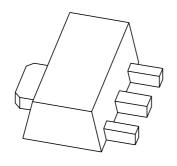
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS4520X 20 V, 5 A NPN low V_{CEsat} (BISS) transistor

Product specification Supersedes data of 2004 Jun 11 2004 Nov 08





20 V, 5 A NPN low V_{CEsat} (BISS) transistor

PBSS4520X

FEATURES

- High hFE and low VCEsat at high current operation
- High collector current capability: I_C maximum 5 A
- Higher efficiency leading to less heat generation.

APPLICATIONS

- Medium power peripheral drivers, e.g. fans and motors
- Strobe flash units for DSC and mobile phones
- Inverter applications, e.g. TFT displays
- · Power switch for LAN and ADSL systems
- Medium power DC-to-DC conversion
- · Battery chargers.

DESCRIPTION

NPN low V_{CEsat} BISS transistor in a SOT89 (SC-62) plastic package.

PNP complement: PBSS5520X.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS4520X	*1F

Note

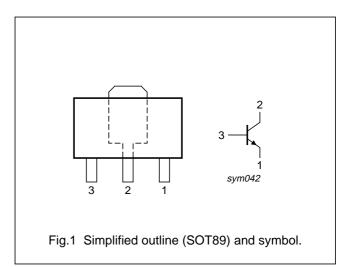
- 1. * = p: made in Hong Kong
 - * = t: made in Malaysia
 - * = W: made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	20	V
I _C	collector current (DC)	5	Α
I _{CM}	peak collector current	10	Α
R _{CEsat}	equivalent on-resistance	44	mΩ

PINNING

PIN	DESCRIPTION
1	emitter
2	collector
3	base



ORDERING INFORMATION

TYPE NUMBER		PACKAGE	
TIFE NOWBER	NAME	DESCRIPTION	VERSION
PBSS4520X	SC-62 plastic surface mounted package; collector pad for transfer; 3 leads		SOT89

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

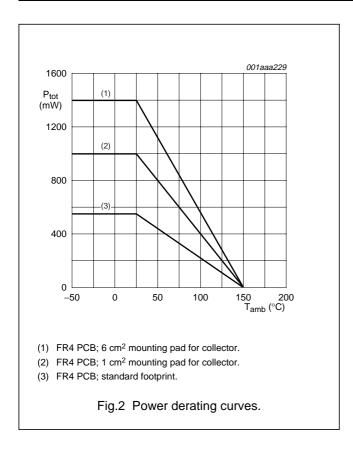
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	20	V
V _{CEO}	collector-emitter voltage	open base	_	20	V
V _{EBO}	emitter-base voltage	open collector	_	5	V
I _C	collector current (DC)		_	5	Α
I _{CRM}	repetitive peak collector current	notes 1 and 2	_	7	Α
I _{CM}	peak collector current	$t_p \le 1 \text{ ms}$	_	10	Α
I _B	base current (DC)		_	1	Α
I _{BM}	peak base current	t _p ≤ 1 ms	_	2	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
		notes 1 and 2	_	2.5	W
		note 2	_	0.55	W
		note 3	_	1	W
		note 4	_	1.4	W
		note 5	_	1.6	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

Notes

- 1. Operated under pulsed conditions: pulse width $t_p \le 10$ ms; duty cycle $\delta \le 0.2$.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
- 4. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².
- 5. Device mounted on a 7 cm² ceramic printed-circuit board, 1 cm² single-sided copper and tin-plated. For other mounting conditions, see *"Thermal considerations for SOT89 in the General Part of associated Handbook"*.

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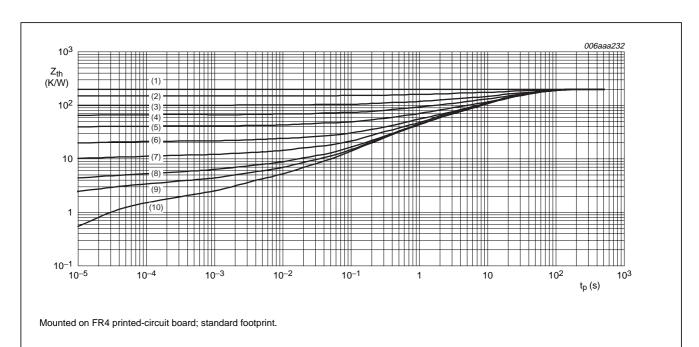
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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
		notes 1 and 2	50	K/W
		note 2	225	K/W
		note 3	125	K/W
		note 4	90	K/W
		note 5	80	K/W
R _{th(j-s)}	thermal resistance from junction to soldering point		16	K/W

Notes

- 1. Operated under pulsed conditions: pulse width $t_p \le 10$ ms; duty cycle $\delta \le 0.2$.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm².
- 4. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm².
- 5. Device mounted on a 7 cm² ceramic printed-circuit board, 1 cm² single-sided copper and tin-plated. For other mounting conditions, see "Thermal considerations for SOT89 in the General Part of associated Handbook".



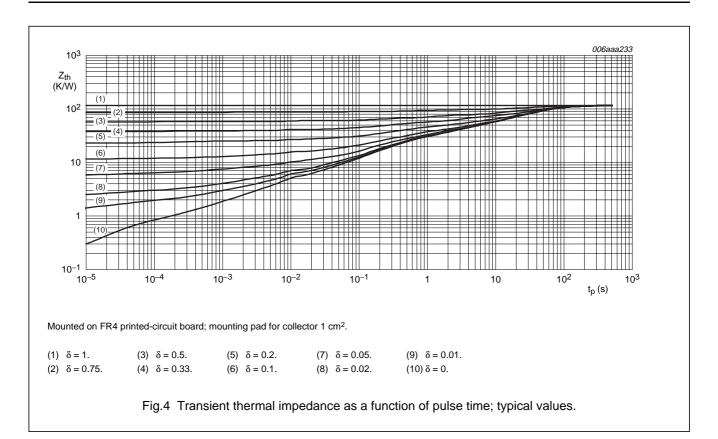
- (1) $\delta = 1$.
- (3) $\delta = 0.5$.
- (5) $\delta = 0.2$.
- (7) $\delta = 0.05$.
- (9) $\delta = 0.01$.

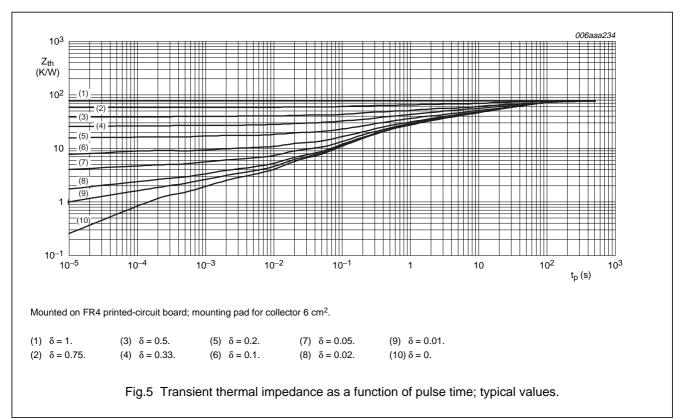
- (2) $\delta = 0.75$.
- (4) $\delta = 0.33$.
- (6) $\delta = 0.1$.
- (8) $\delta = 0.02$.
- $(10) \delta = 0.$

Fig.3 Transient thermal impedance as a function of pulse time; typical values.

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CHARACTERISTICS

 T_{amb} = 25 $^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 20 V; I _E = 0 A	-	_	100	nA
		V _{CB} = 20 V; I _E = 0 A; T _j = 150 °C	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$	_	_	100	nA
I _{CES}	collector-emitter cut-off current	V _{CE} = 20 V; V _{BE} = 0 V	_	_	100	nA
h _{FE}	DC current gain	V _{CE} = 2 V				
		I _C = 0.5 A	300	450	_	
		I _C = 1 A; note 1	300	440	_	
		I _C = 2 A; note 1	250	420	_	
		I _C = 5 A; note 1	200	380	_	
V _{CEsat}	collector-emitter saturation	I _C = 0.5 A; I _B = 5 mA	_	35	50	mV
	voltage	I _C = 1 A; I _B = 10 mA	-	50	70	mV
		I _C = 2.5 A; I _B = 125 mA; note 1	_	85	120	mV
		I _C = 4 A; I _B = 200 mA; note 1	-	130	180	mV
		I _C = 5 A; I _B = 500 mA; note 1	_	160	220	mV
R _{CEsat}	equivalent on-resistance	I _C = 5 A; I _B = 500 mA; note 1	_	32	44	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 4 A; I _B = 200 mA; note 1	-	0.9	1.05	V
		I _C = 5 A; I _B = 500 mA; note 1	-	0.96	1.1	V
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 2 V; I _C = 2 A	_	0.74	0.85	V
f _T	transition frequency	I _C = 100 mA; V _{CE} = 10 V; f = 100 MHz	100	125	_	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	_	90	110	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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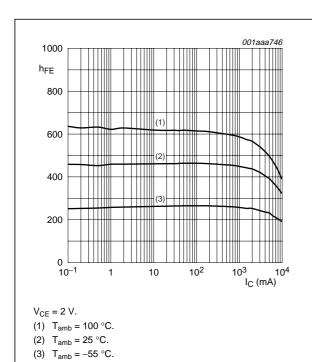
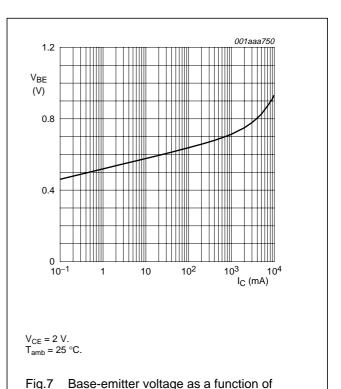
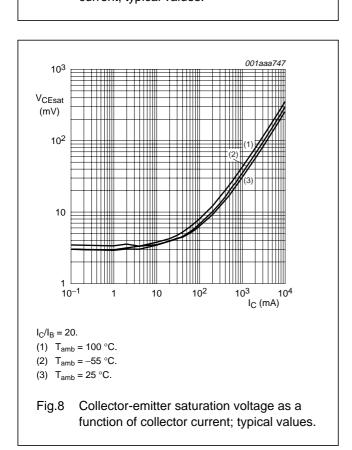
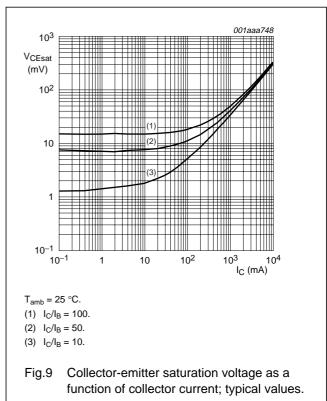


Fig.6 DC current gain as a function of collector current; typical values.







collector current; typical values.

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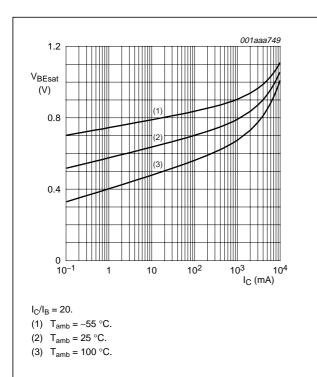
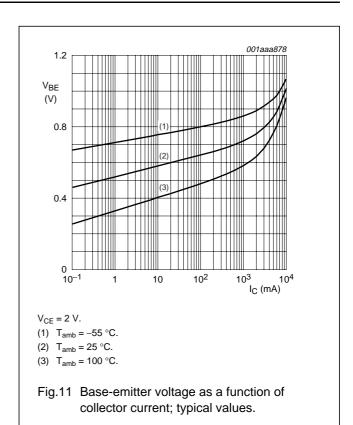
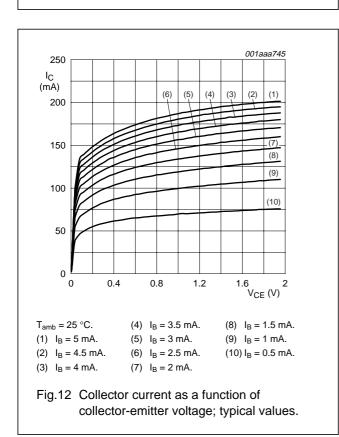
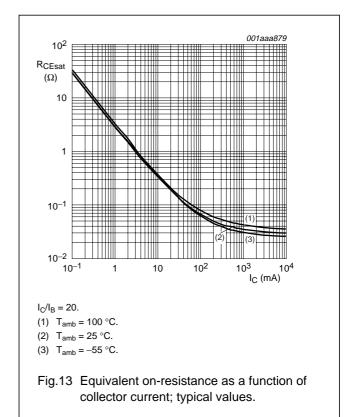


Fig.10 Base-emitter saturation voltage as a function of collector current; typical values.



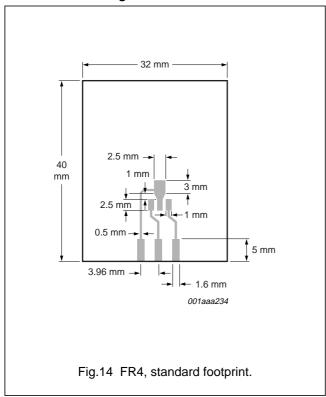


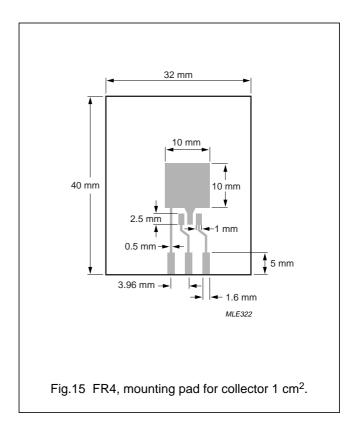


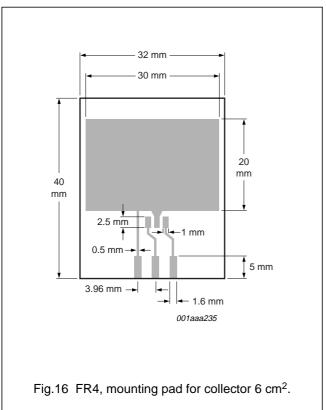
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Reference mounting conditions







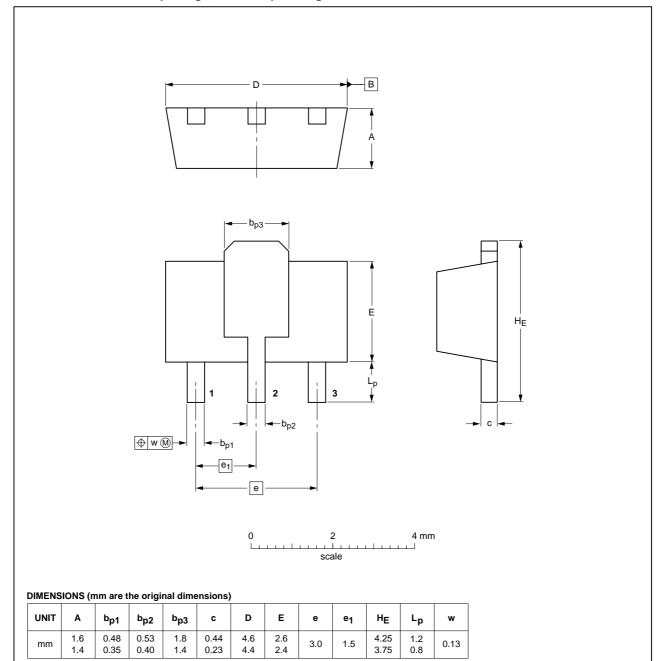
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89



VERSION IEC JEDEC JEITA	PROJECTION	ISSUE DATE
SOT89 TO-243 SC-62		99-09-13 04-08-03

20 V, 5 A NPN low V_{CEsat} (BISS) transistor

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
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